MA2Z7850G

Silicon epitaxial planar type

For super high speed switching For small current rectification

■ Features

- High-density mounting is possible
- Forward current (Average) I_{F(AV)} = 100 mA rectification is possible
- Optimum for high frequency rectification because of its short reverse recovery time t_{rr}
- Low forward voltage V_F and good rectification efficiency
- Reverse voltage $V_R = 50 \text{ V}$ is guaranteed

Package

- Code
- SMini2-F3
- Pin Name
 - 1: Anode 2: Cathode
- Marking Symbol: 2E

■ Absolute Maximum Ratings T_a = 25°C

Parameter	Symbol	Rating	Unit
Reverse voltage	V_R	50	V
Repetitive peak reverse voltage	V _{RRM}	50	V
Forward current (Average)	I _{F(AV)}	100	mA
Peak forward current	I_{FM}	300	mA
Non-repetitive peak forward surge current *	I_{FSM}	1	A
Junction temperature	Tj	125	°C
Storage temperature	T _{stg}	-55 to +125	O °C

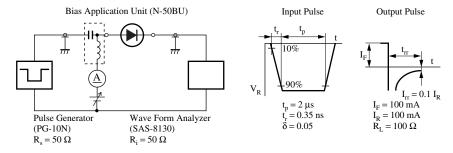
Note) *: The peak-to-peak value in one cycle of 50 Hz sine wave (non-repetitive)

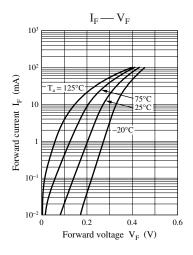
■ Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

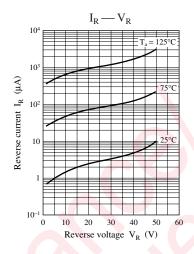
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	$V_{\rm F}$	$I_F = 100 \text{ mA}$	03/		0.55	V
Reverse current	I_R	$V_R = 50 \text{ V}$	1.1		30	μΑ
Terminal capacitance	C _t	$V_R = 0 V, f = 1 MHz$		25		pF
Reverse recovery time *	t _{rr}	$I_F = I_R = 100 \text{ mA}$		3.0		ns
* C		$I_{rr} = 0.1 I_R, R_L = 100 \Omega$				

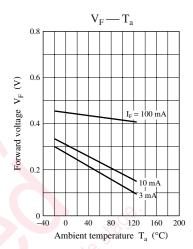
- Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.
 - This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.
 - 3. Absolute frequency of input and output is 200 MHz.

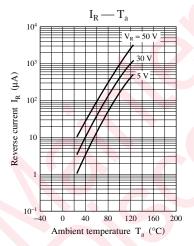
4. *: t_{rr} measurement circuit

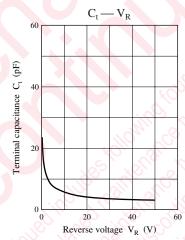


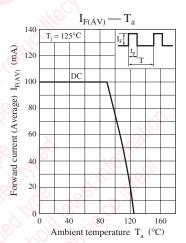






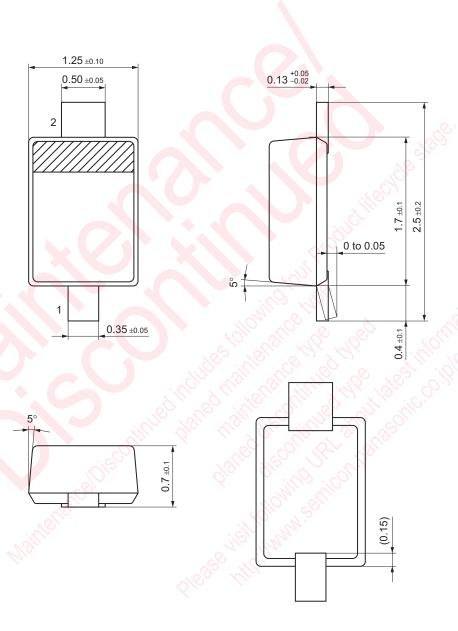






2 SKH00188AED

SMini2-F3 Unit: mm



SKH00188AED 3

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